



**PROJECT INITIATION  
NOTIFICATION SYSTEM FORM**

Project Registration Date (dd-mmm-yyyy) completed by EIA:	16-MAY-2005
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**Electronic Industries Alliance PINS: (01OCT2004)**

1. Project Number Assigned by EIA:	PN-5094		
2. Final Published Document Number Assigned:	EIA-595-A		
3. Title of Final Published Document:	VISUAL & MECHANICAL INSPECTION Multilayer Ceramic Chip Capacitors		
4. Project Intent: (Check the applicable box(s) below)			
Create a New Document		Modify Existing Document	
EIA Component Bulletin	<input type="checkbox"/>	Revise current published document	<input checked="" type="checkbox"/>
EIA standard	<input type="checkbox"/>	Revise and Redesignate current published document	<input type="checkbox"/>
Joint Industry Document	<input type="checkbox"/>	Revise, Redesignate and Consolidate current document	<input type="checkbox"/>
Create new American National Standard (ANSI)	<input type="checkbox"/>	Revise and Partition current document	<input type="checkbox"/>
Conduct Survey	<input type="checkbox"/>	Reaffirm current document	<input type="checkbox"/>
Other (Please explain)	<input type="checkbox"/>	Reaffirm and Redesignate current document	<input type="checkbox"/>
		Supplement to a current document	<input type="checkbox"/>
		Withdraw current document	<input type="checkbox"/>
5. Estimated Project Completion Date (mmm yy):		Convert to Historical Document designation	<input type="checkbox"/>
Sep 05		Other (Please explain)	<input type="checkbox"/>
6. Description of Contents of Document: (Provide a one paragraph description, not to exceed 500 characters.)			
This document covers the general industry inspection requirements for multilayer ceramic chip capacitors. The devices selected for inspection may be examined under 10 to 20 power magnification to determine compliance with the requirements specified herein. Increased magnification may be used when negotiated between the manufacturer and the user/buyer. Sampling plans or lot accept/reject criteria shall be negotiated between the manufacturer and the user/buyer.			
7. Units of Measurement Used: (check applicable boxes)	<input checked="" type="checkbox"/> Metric	<input checked="" type="checkbox"/> US	<input type="checkbox"/> Non-Measurement Sensitive
8. Formulating Body (Organization, Committee/Subcommittee Title and Acronym):	P2.1		
9. Designated Formulating Group Project Author/Editor/Leader: (Specify name and complete contact information, address, phone, email, etc. If none is indicated, Default Project Point Contact will be Formulating Group Chair as completed in 9. below.)			
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10. Formulating Group Chair: (Specify name and complete contact information, address, phone, email, etc.)			
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